

Thyristor

Low Power Use

REJ03G0356-0100

Rev.1.00

Aug.20.2004

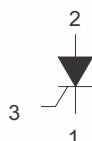
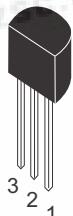
Features

- $I_{T(AV)}$: 0.3 A
- V_{DRM} : 800 V
- I_{GT} : 100 μ A

- Non-Insulated Type
- Glass Passivation Type

Outline

TO-92



- Cathode
- Anode
- Gate

Applications

Leakage protector, timer, and gas igniter

Maximum Ratings

Parameter	Symbol	Voltage class		Unit
		16	800	
Repetitive peak reverse voltage	V_{RRM}		800	V
Non-repetitive peak reverse voltage	V_{RSM}		960	V
DC reverse voltage	$V_{R(DC)}$		640	V
Repetitive peak off-state voltage ^{Note1}	V_{DRM}		800	V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}		960	V
DC off-state voltage ^{Note1}	$V_{D(DC)}$		640	V

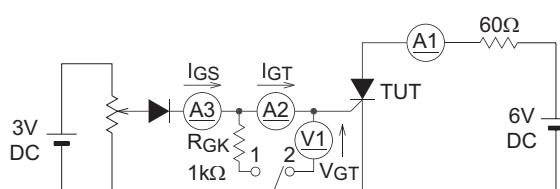
Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I_T (RMS)	0.47	A	
Average on-state current	I_T (AV)	0.3	A	Commercial frequency, sine half wave 180° conduction, $T_a = 47^\circ C$
Surge on-state current	I_{TSM}	10	A	60Hz sine half wave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	0.4	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	0.5	W	
Average gate power dissipation	P_G (AV)	0.1	W	
Peak gate forward voltage	V_{FGM}	6	V	
Peak gate reverse voltage	V_{RGM}	6	V	
Peak gate forward current	I_{FGM}	0.3	A	
Junction temperature	T_j	-40 to +110	°C	
Storage temperature	T_{stg}	-40 to +125	°C	
Mass	—	0.23	g	Typical value

Notes: 1. With gate to cathode resistance $R_{GK} = 1 k\Omega$.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak reverse current	I_{RRM}	—	—	0.1	mA	$T_j = 110^\circ C$, V_{RRM} applied
Repetitive peak off-state current	I_{DRM}	—	—	0.1	mA	$T_j = 110^\circ C$, V_{DRM} applied, $R_{GK} = 1 k\Omega$
On-state voltage	V_{TM}	—	—	1.8	V	$T_a = 25^\circ C$, $I_{TM} = 4 A$, instantaneous value
Gate trigger voltage	V_{GT}	—	—	0.8	V	$T_j = 25^\circ C$, $V_D = 6 V$, $I_T = 0.1 A^{Note2}$
Gate non-trigger voltage	V_{GD}	0.2	—	—	V	$T_j = 110^\circ C$, $V_D = 1/2 V_{DRM}$, $R_{GK} = 1 k\Omega$
Gate trigger current	I_{GT}	1	—	100	μA	$T_j = 25^\circ C$, $V_D = 6 V$, $I_T = 0.1 A^{Note2}$
Holding current	I_H	—	1.5	3	mA	$T_j = 25^\circ C$, $V_D = 12 V$, $R_{GK} = 1 k\Omega$
Thermal resistance	$R_{th(j-a)}$	—	—	180	°C/W	Junction to ambient

Notes: 2. I_{GT} , V_{GT} measurement circuit.



Switch 1 : I_{GT} measurement

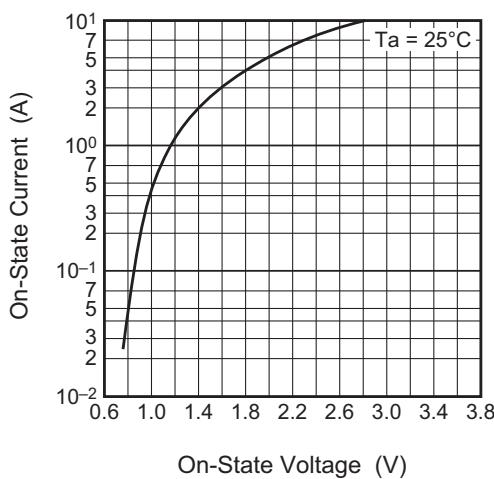
Switch 2 : V_{GT} measurement

(Inner resistance of voltage meter is about $1 k\Omega$)

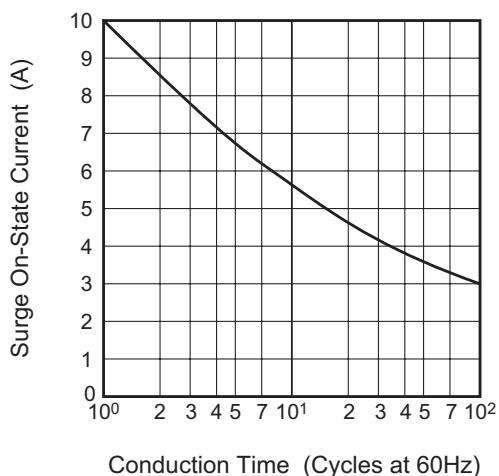
Performance Curves

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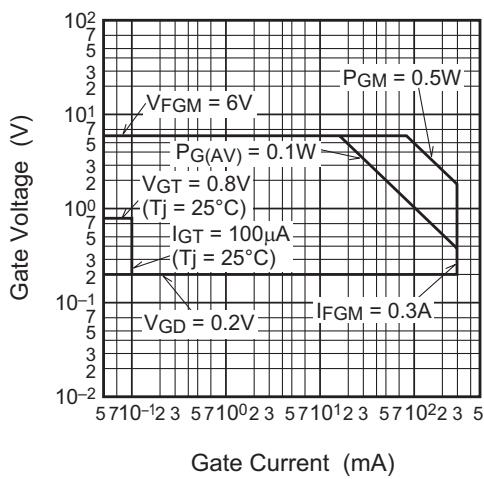
Maximum On-State Characteristics



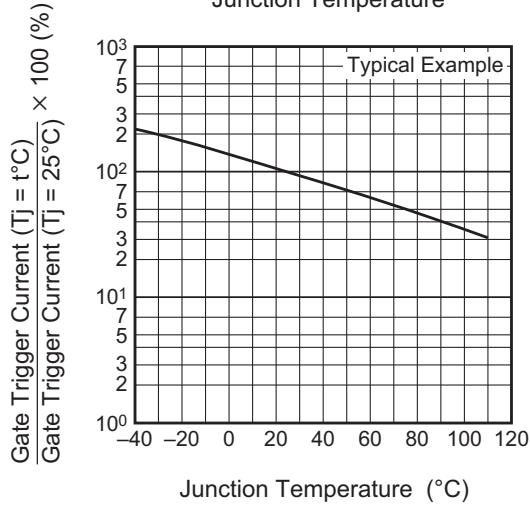
Rated Surge On-State Current



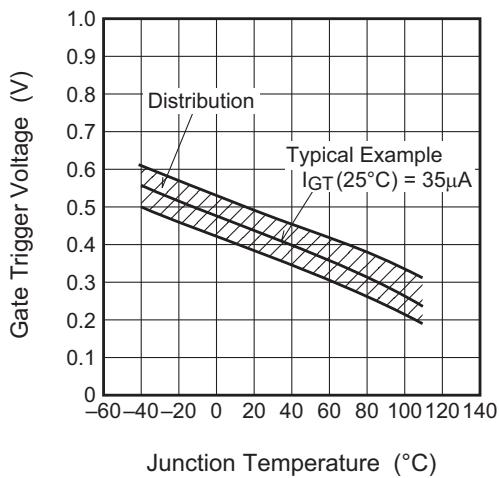
Gate Characteristics



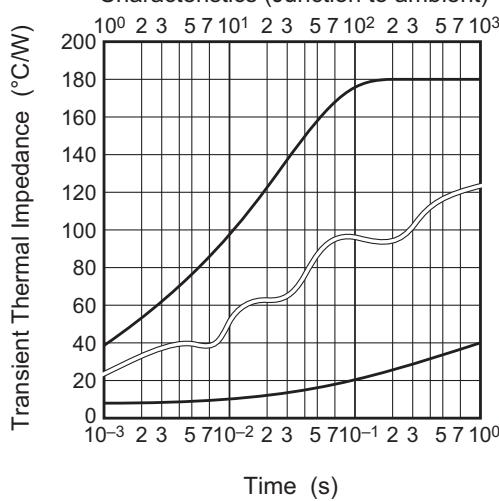
Gate Trigger Current vs. Junction Temperature



Gate Trigger Voltage vs. Junction Temperature

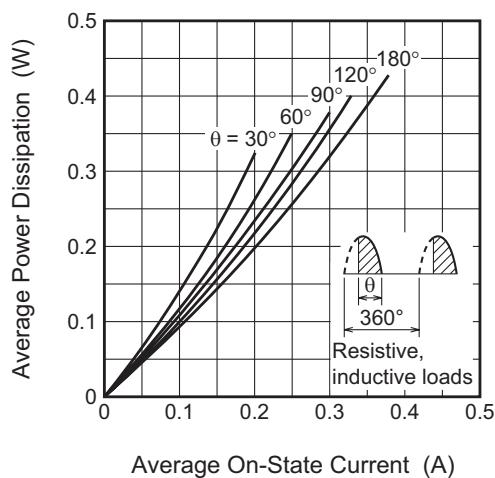


Maximum Transient Thermal Impedance Characteristics (Junction to ambient)

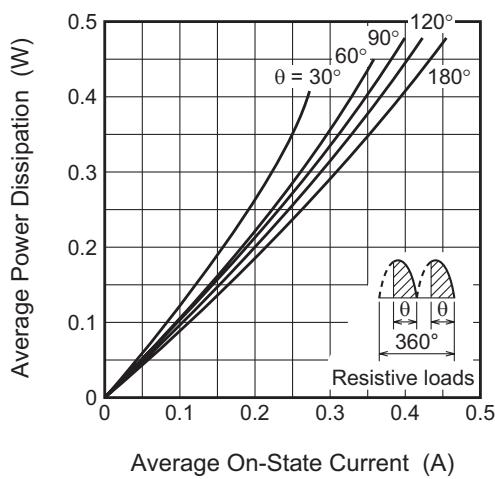


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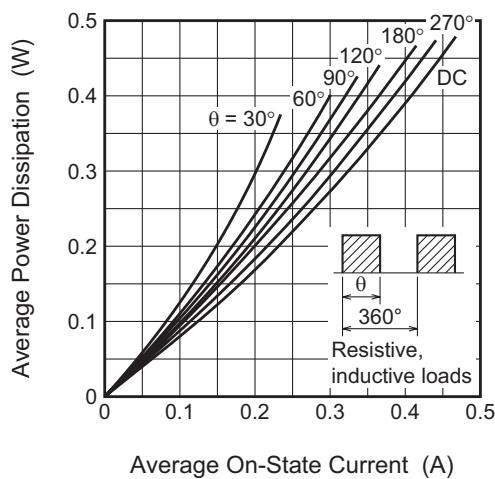
Maximum Average Power Dissipation
(Single-Phase Half Wave)



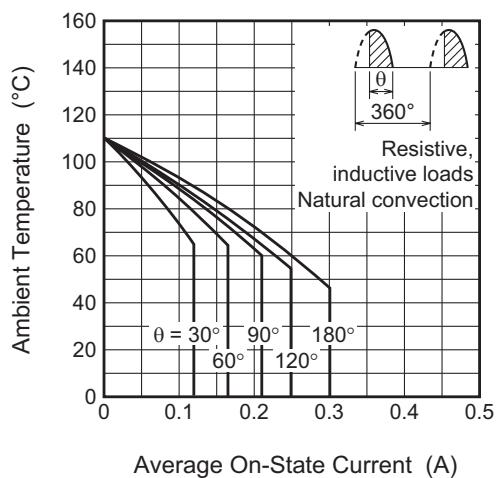
Maximum Average Power Dissipation
(Single-Phase Full Wave)



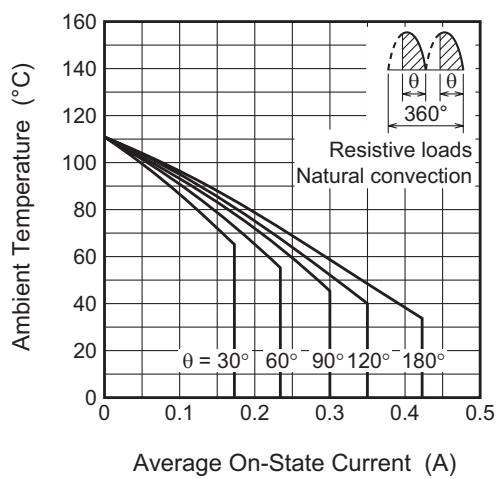
Maximum Average Power Dissipation
(Rectangular Wave)



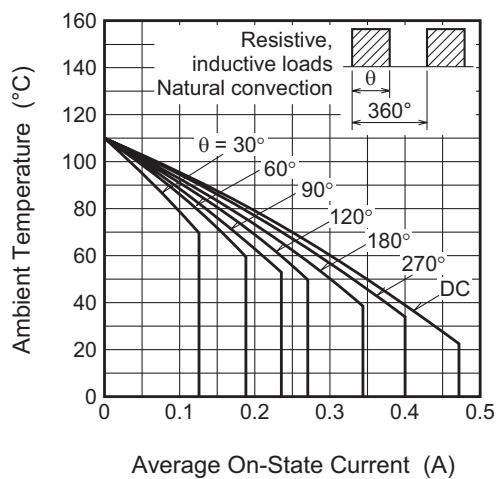
Allowable Ambient Temperature vs.
Average On-State Current
(Single-Phase Half Wave)



Allowable Ambient Temperature vs.
Average On-State Current
(Single-Phase Full Wave)

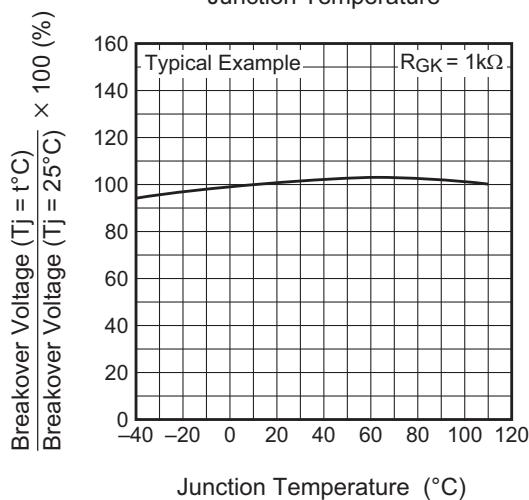


Allowable Ambient Temperature vs.
Average On-State Current
(Rectangular Wave)

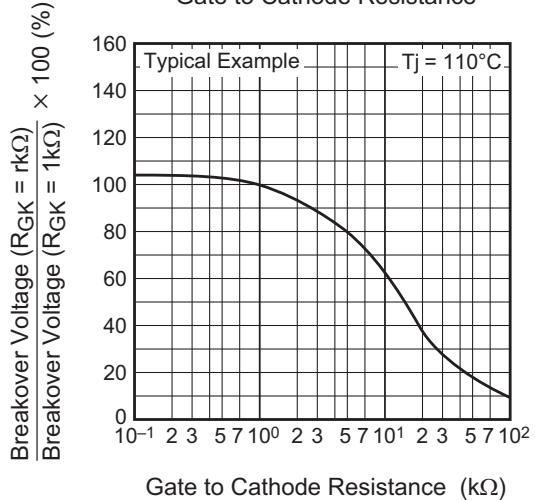


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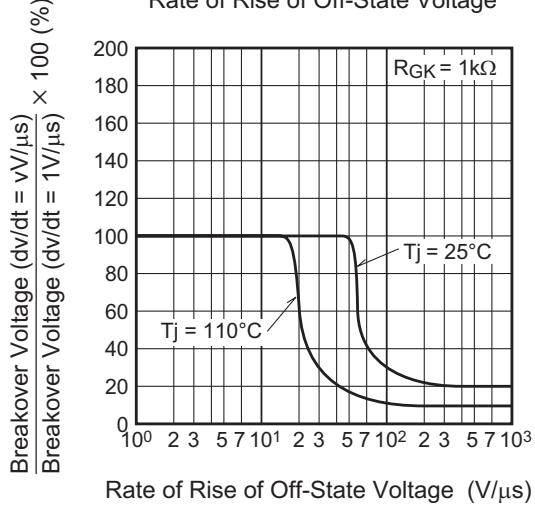
Breakover Voltage vs.
Junction Temperature



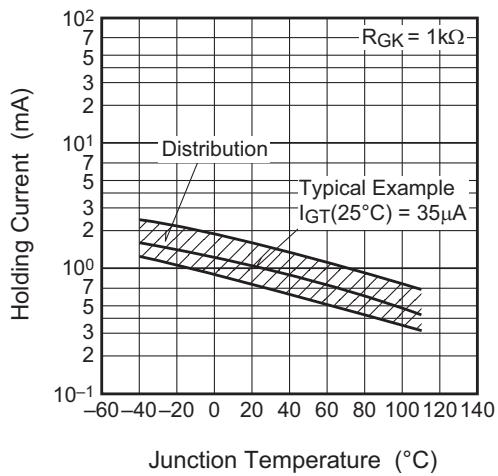
Breakover Voltage vs.
Gate to Cathode Resistance



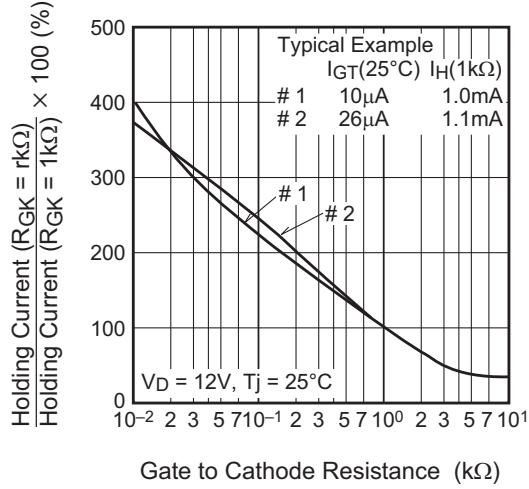
Breakover Voltage vs.
Rate of Rise of Off-State Voltage



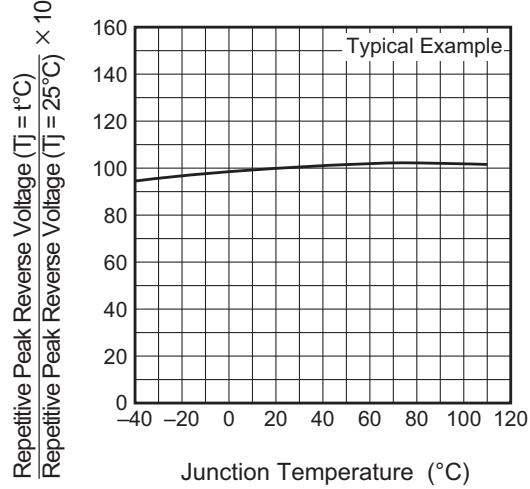
Holding Current vs.
Junction Temperature



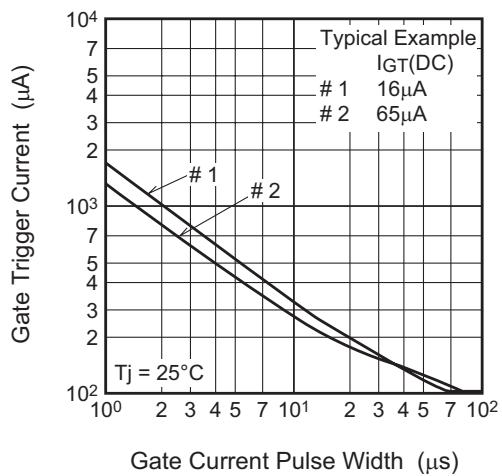
Holding Current vs.
Gate to Cathode Resistance



Repetitive Peak Reverse Voltage vs.
Junction Temperature

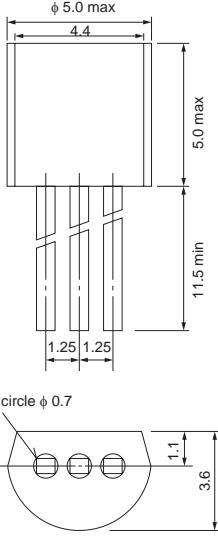
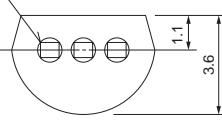


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Gate Trigger Current vs.
Gate Current Pulse Width



Packaging Dimensions 供应商

TO-92

EIAJ Package Code Conforms	JEDEC Code Conforms	Mass (g) (reference value) 0.23	Lead Material Cu alloy																																																																	
																																																																				
																																																																				
<p>Note 1) The dimensional figures indicate representative values unless otherwise the tolerance is specified.</p> <table border="1"> <thead> <tr> <th>Symbol</th> <th>Dimension in Millimeters</th> <th>Min</th> <th>Typ</th> <th>Max</th> </tr> </thead> <tbody> <tr><td>A</td><td></td><td></td><td></td><td></td></tr> <tr><td>A₁</td><td></td><td></td><td></td><td></td></tr> <tr><td>A₂</td><td></td><td></td><td></td><td></td></tr> <tr><td>b</td><td></td><td></td><td></td><td></td></tr> <tr><td>D</td><td></td><td></td><td></td><td></td></tr> <tr><td>E</td><td></td><td></td><td></td><td></td></tr> <tr><td>e</td><td></td><td></td><td></td><td></td></tr> <tr><td>x</td><td></td><td></td><td></td><td></td></tr> <tr><td>y</td><td></td><td></td><td></td><td></td></tr> <tr><td>y₁</td><td></td><td></td><td></td><td></td></tr> <tr><td>ZD</td><td></td><td></td><td></td><td></td></tr> <tr><td>ZE</td><td></td><td></td><td></td><td></td></tr> </tbody> </table>				Symbol	Dimension in Millimeters	Min	Typ	Max	A					A ₁					A ₂					b					D					E					e					x					y					y ₁					ZD					ZE				
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Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	500	Type name	CR05AM-16
Lead form	Vinyl sack	500	Type name – Lead forming code	CR05AM-16-A6
Form A8	Taping	2000	Type name – TB	CR05AM-16-TB

Note : Please confirm the specification about the shipping in detail.

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